



1SC3535VGB00MD01

- **♦**Outline (L* W*H): 3.5*3.5*2.8mm
- **◆**Good thermal dissipation & optical uniformity

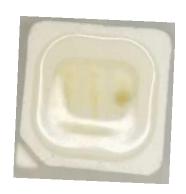


Table of Contents

Product Code Method		 	2
Maximum Rating		 	2
Typical Product Characteristics		 	3
Directive Characteristics		 	4
Electronic-Optical Characteristics		7	5
Dimensions			6
Packing		 	7
Precautions		 	8
Test Items and Results of Reliability		 	1

Features

- Forward current: ≤30mA
- Typical view angle 50% Iv: 120°
- Lens color: white diffused
- RoHS and REACH-compliant
- Qualified according to JEDEC moisturevity
 Level 3
- ESD level 1kV(HBM)

Applications

- Indoor and outdoor display
- Outdoor lighting for amusement
- Consumer electronics
- Other applications

 $^{\rm o}$ C

260



■ Product Code Method

1 - S - C - 3535 - VGB0 - 0 - M - D - 01

① ② ③ ④ ⑤ ⑦ ⑧ ②

1)	2	3	4	(5)
Process Type	Category	LED Type	Lead Frame Size	Dice wavelength & luminous rank
1: normal process	S: SMD LED	C: PLCC top view D: PLCC side view	3535: 3.5*3.5mm	V:red G:green B:blue

6		8	9
Lap Polarity	Cap Color	PCB Module Code	Flow Code
0: non-common anode and non-common cathode	M: white diffused	D: article mode	01: no expression above meaning for company

■ Maximum Rating($Ta=25^{\circ}C$)

Characteristics **Symbol Rating** Unit DC Forward Current 30 I_F mΑ Pulse Forward Current*3 100 I_{PF} mA 5 V V_R Reverse Voltage $^{\rm o}$ C Junction Temperature $T_{\rm J}$ 110 -40~85 $^{\rm o}C$ Operating Temperature Range T_{OP} $^{\rm o}C$ Storage Temperature Range -40~100 T_{STG}

Notes 1: There is no maximum or typical voltage parameter

2: For other ambient, limited setting of current will be depended on de-rating curves.

 T_{SD}

3: Duty 1/10, pulse width 0.1ms

Soldering Temperature*4

4: The maximum of soldering time is 5 seconds in T_{SD}

 $I_F=20mA$



■ Typical Product Characteristics(Ta=25°C)

Symbol Characteristics Min. Typ. Max. Unit **Test condition** R 1.8 2.6 \mathbf{G} 2.8 3.6 Forward Voltage V_{F} V $I_F=20mA$ В 2.8 3.6 $V_R = 5V$ Reverse Current 10 μΑ I_R R 440 653 967 G 1230 1720 2704 **Luminous Intensity** Iv mcd $I_F=20mA$ В 260 390 572 R 618 628 G Dominant Wavelength λd 520 530 $I_F=20mA$ nm

Notes: 1. Measurement Errors:

View Angle

Forward Voltage: ±0.1V, Luminous Intensity: ±10%Iv, Dominant Wavelength: ±1.0nm

465

- 2. Electrical-Optical Characteristics (Ta=25°C)
- 3. We will amend the Bin code to maintain Bin Code centralize,

 $2\theta_{1/2}$

В

And we get the Luminous Intensity is 1.3double per Bins and the Dominant Wavelength is 5/3/3nm of R/G/B per Bins

120

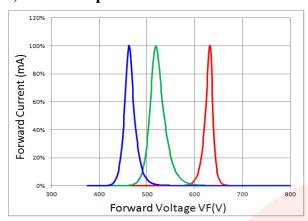
475

deg

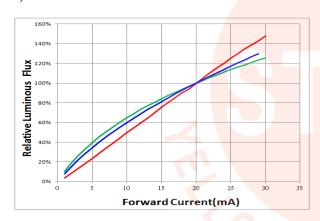


■ Electronic-Optical Characteristics

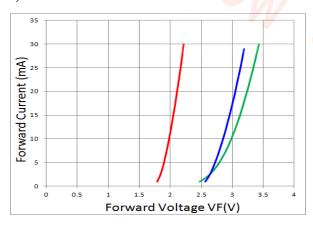
1). Relative Spectral Distribution



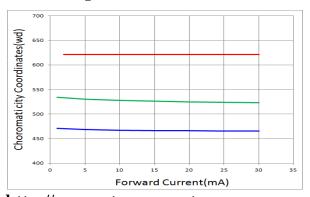
3). Relative Luminous Flux .Current



5). Electrical Characteristics

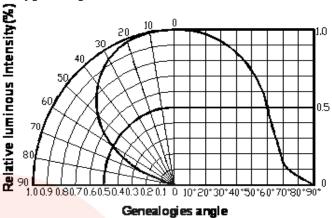


7). Wavelength and Current

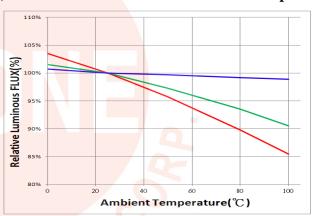


http://www.ystone.com.tw

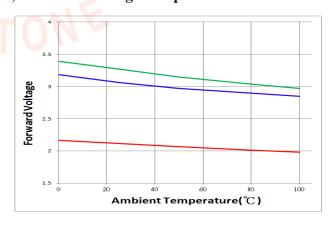
2). Typical Spatial Distribution



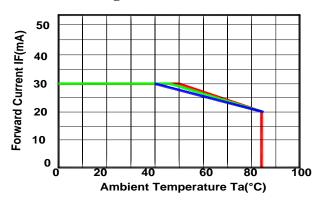
4). Relative Luminous Flux . Ambient Temperature



6). Forward Voltage Temperature



8). Thermal Design

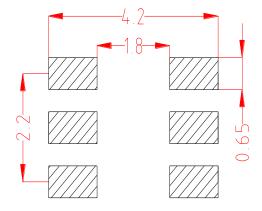




Dimensions

3.70 6 2.20 0.80 0.60 2.20 0.60 2.10 8 0.60

Recommend Padlayout



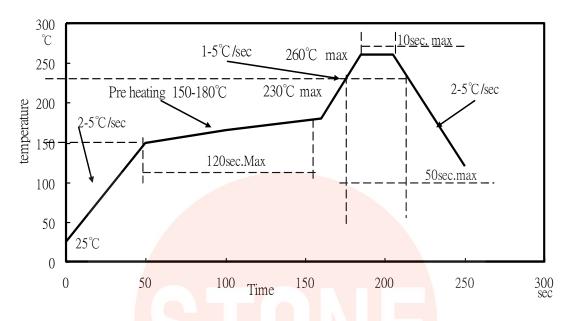
- § All dimensions are in millimeters.
- § Tolerance is ±0.1mm unless other specified
- § Specifications are subject to change without notice



■ Reflow Profile

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1. I_R reflow soldering Profile for Lead Free solder



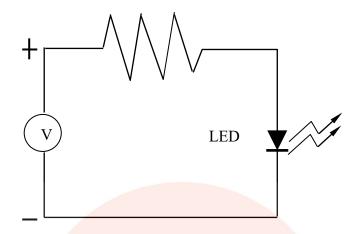
Notes:

- 1. We recommend the reflow temperature 240° C ($\pm 5^{\circ}$ C).the maximum soldering temperature should be limited to 260° C.
- 2. Don't cause stress to the silicone resin while it is exposed to high temperature.
- 3. Number of reflow process shall not be more than 1 time.



■ Test Circuit and Handling Precautions

1. Test circuit



2. Handling precautions

2.1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2.2. Storage

1). It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: $5^{\circ}\text{C} \sim 30^{\circ}\text{C} (41^{\circ}\text{F} \sim 86^{\circ}\text{F})$

2). Shelf life in sealed bag: 12 months at $<5^{\circ}\text{C}\sim30^{\circ}\text{C}$ and <60% R.H. after the package is Opened, the products should be used within 1 weeks or they should be keeping to stored at $\leq 20\%$ R.H. with zip-lock sealed.

2.3. Baking

Suggest packing open after 1 weeks, before use baking products, conditions as follows:

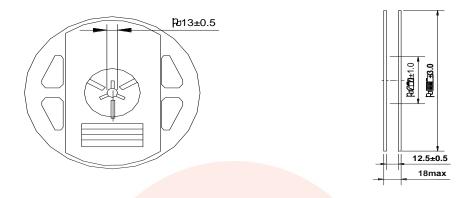
- 1). $60\pm3^{\circ}$ C X 6hrs and <5%RH, for reel
- 2). $125\pm3^{\circ}$ C X 2hrs, for single LED

It shall be normal to see slight color fading of carrier (light yellow) after baking in process



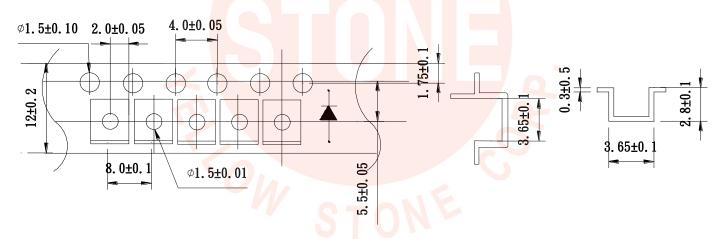
Packing

Dimensions of Reel (Unit: mm)

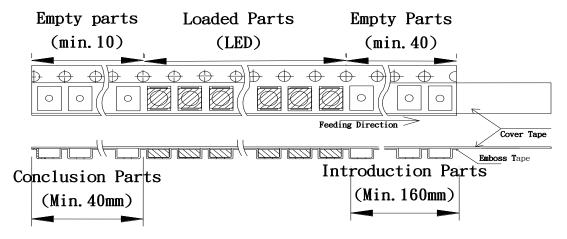


Note: 01. The tolerance unless mentioned is ±0.2 mm. 02. The measured unit is "mm".

Dimensions of Tape (Unit: mm)



Arrangement of Tape

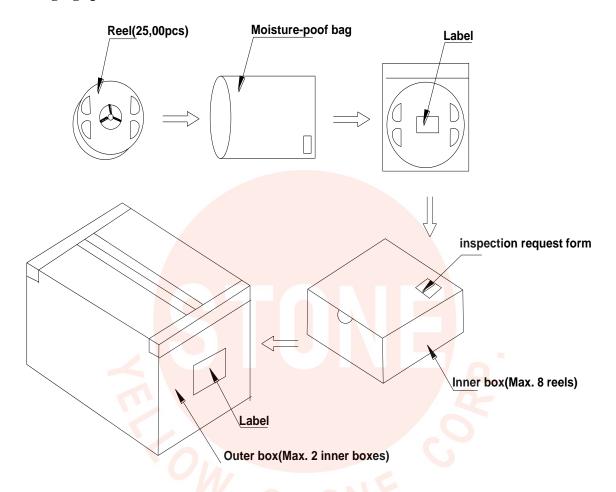


- **Notes:** 1. Empty component pockets are sealed with top cover tape
 - 2. The max loss number of SMD is 2pcs
 - 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications
 - 4. 2500pcs per reel



Packing

Packaging specifications



Notes:

Reeled product (max.2500) is packed in a sealed moisture-proof bag. Five bags are packed in an inner box (size: about 340 X 340 X 150 mm) and four inner boxes are in an outer box (size: about 685 X 355 X 400mm). On the label of moisture-poof bag, there should be the information of Part No., Lot No. and quantity number; also the total quantity number should be on inspection request form on outer box.



Precautions

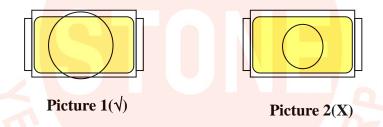
1. Abnormal situation caused by improper setting of collet

To choose the right collet is the key issue in improving the product's quality. LED is different from other electronic components, which is not only about electrical output but also for optical output. This characteristic made LED more fragile in the process of SMT. If the collet's lowering down height is not well set, it will bring damage to the gold wire at the time of collet's picking up and loading which will cause the LED fail to light up, light up now and then or other quality problems

2. How to choose the collet

During SMT, please choose the collet that has larger outer diameter than the lighting area of lens, in case that improper position of collet will damage the gold wire inside the LED. Different collets fit for different products, please refer to the following pictures cross out

Outer diameter of collet should be larger than the lighting area



3. Other points for attention

- A. No pressure should be exerted to the epoxy shell of the SMD under high temperature.
- B. Do not scratch or wipe the lens since the lens and gold wire inside are rather fragile and cross out easy to break.
- C. LED should be used as soon as possible when being taken out of the original package, and should be stored in anti-moisture and anti-ESD package.
- 4. This usage and handling instruction is only for your reference.



■ Test Items and Results of Reliability

Test Item	Test Conditions	Duration/ Cycle	Ac/Re	Number of Damage	Reference
Normal Temperature Life	$Ta=23^{\circ}C(\pm 5^{\circ}C)$ $I_F=20mA$	1008 hrs	0/1	0/22	JESD22 A-108
High Temperature Life	$Ta=85^{\circ}C(\pm 5^{\circ}C)$ $I_F=20\text{mA}$	1008 hrs	0/1	0/22	JESD22 A-108
High Humidity Heat Life	$Ta = 85^{\circ}C(\pm 5^{\circ}C)$ $RH = 85\%$ $I_{F} = 20\text{mA}$	1008 hrs	0/1	0/22	JESD22 A-108
Thermal shock	-45°C/30min~105°C /30min (±5°C)	1008 hrs	0/1	0/22	JESD22 A-104
Electrostatic Discharge (ESD) Test	According to the SPEC	3 cycles	0/1	0/22	AEC Q101-001
Low Temperature Storage	T _a =-40°C	1008 hrs	0/1	0/22	JESD22-A103D
High Temperature Storage	T _a =125℃	1008 hrs	0/1	0/22	JESD22-A103D

*Criteria for Judging					
Itom	Crossb al	C 114:	Criteria for Judgment of Pass		
Item	Symbol	Condition	Min	Max	
Forward Voltage	V_{F}	I _F =20mA	-	USL* ¹ ×1.1	
Reverse Current	I_R	$V_R = 5V$	-	10μΑ	
Luminous Intensity	Iv	I _F =20mA	LSL*2×0.7	-	

[Note] USL*1: Upper Specification Level

LSL*²: Lower Specification Level